



Product Change Notification

Change Notification #: 118777-00
Change Title: Select Intel® MAX® 10 Devices,
PCN 118777-00, Documentation,
Family Pin Connection Guidelines Update
Date of Publication: December 08, 2021

Key Characteristics of the Change:

Documentation

Forecasted Key Milestones:

Availability of MAX 10 Device Pin Connection Guidelines Update	Now
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Description of Change to the Customer:

This is the same change described in ADV2143 issued on December 3, 2021.

Intel is notifying customers of an update to the MAX® 10 Device Family Pin Connection Guidelines. Below is the update listed in the MAX 10 Device Family Pin Connection Guidelines.

- Updated the 1.0-V VCCIO note in the connection guidelines of the VCCIO [#] pins in the Intel MAX 10 (Single Supply) FPGA and Intel MAX 10 (Dual Supply) FPGA.

The updated MAX 10 Device Family Pin Connection Guidelines can be found here:

<https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/dp/max-10/pcg-01018.pdf>

Customer Impact of Change and Recommended Action:

Customers are requested to take note of the changes and determine the impact on their designs.

For questions or support, please contact your local Field Applications Engineer (FAE), or submit a question or request at the My Intel support page, log-in via:

<https://www.intel.com/content/www/us/en/my-intel/fpga-sign-in.html>

Products Affected/Intel Ordering Codes:

All MAX 10 devices.

The list of affected part numbers (OPNs) can be downloaded in Excel form:

<https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/pcn/adv2143-opn-list.xlsx>

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
December 08, 2021	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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